

# **OCMOS FET** PS7341C-1A, PS7341CL-1A

# **CURRENT LIMIT TYPE** 6-PIN DIP, HIGH ISOLATION VOLTAGE 1-ch Optical Coupled MOS FET

-NEPOC Series-

Solid State Relay

### DESCRIPTION

The PS7341C-1A and PS7341CL-1A are solid state relays containing GaAs LEDs on the light emitting side (input side) and MOS FETs including current control circuit on the output side. Current control circuit of OCMOS FET protects this device from thermal breakdown and output circuit.

They are suitable for analog signal control because of their low offset and high linearity.

The PS7341CL-1A has a surface mount type lead.

### **FEATURES**

- Limit current (ILMT = 125 to 250 mA)
- High isolation voltage (BV = 3 750 Vr.m.s.)
- 1 channel type (1 a output)
- Low LED operating current ( $I_F = 2 \text{ mA}$ )
- Designed for AC/DC switching line changer
- Small package (6-pin DIP)
- Low offset voltage
- Ordering number of taping product : PS7341CL-1A-E3, E4: 1 000 pcs/reel

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- Pb-Free product <R> Safety standards
  - UL approved: File No. E72422
  - BSI approved: No. 8252/8253
  - CSA approved: No. CA 101391
  - SEMKO approved: No. 606398
  - DEMKO approved: No. 309836
  - NEMKO approved: No. P00100964
  - FIMKO approved: No. FI 15188
  - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

### **APPLICATIONS**

- Exchange equipment
- Measurement equipment
- FA/OA equipment

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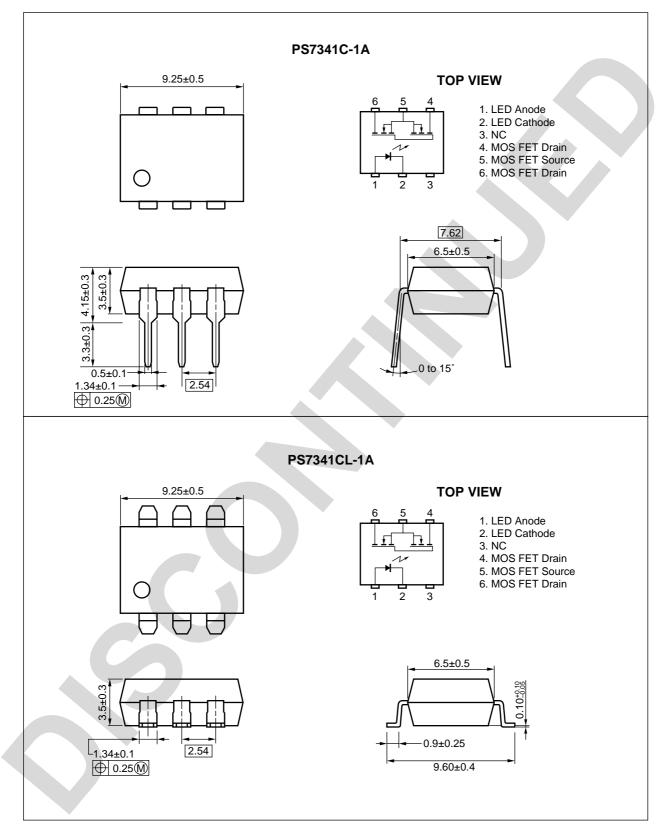
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The mark <R> shows major revised points.

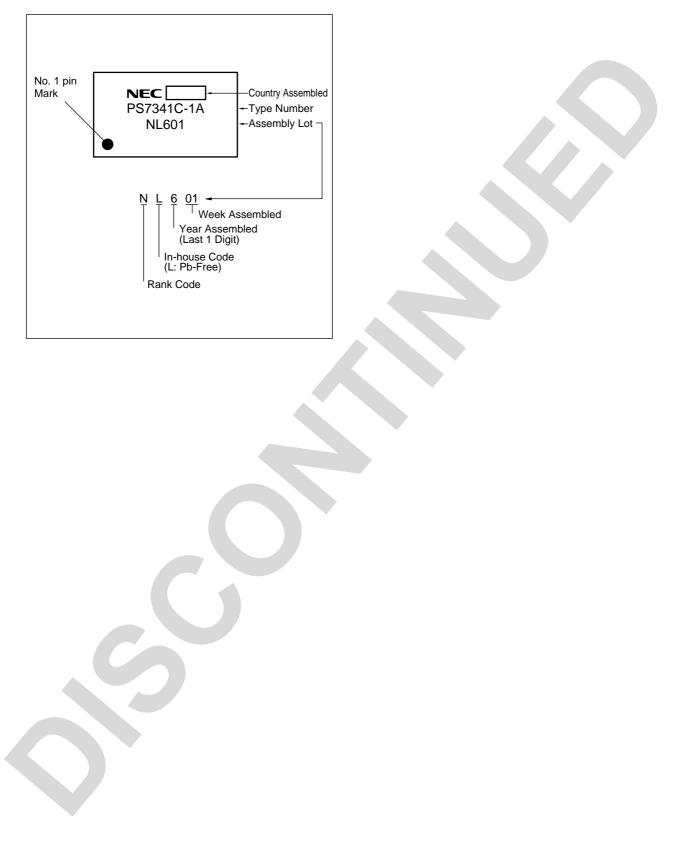
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The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

## PACKAGE DIMENSIONS (in millimeters)



### <R> MARKING EXAMPLE



### <R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number <sup>*1</sup>
PS7341C-1A	PS7341C-1A-A	Pb-Free	Magazine case 50 pcs	Standard products	PS7341C-1A
PS7341CL-1A	PS7341CL-1A-A			(UL, BSI, CSA, SEMKO,	
PS7341CL-1A-E3	PS7341CL-1A-E3-A		Embossed Tape 1 000 pcs/reel	DEMKO, NEMKO,	
PS7341CL-1A-E4	PS7341CL-1A-E4-A			FIMKO approved)	

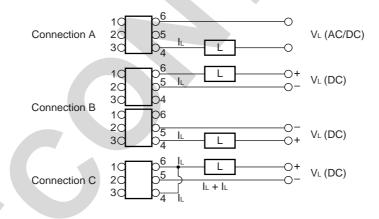
\*1 For the application of the Safety Standard, following part number should be used.

### ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter			Symbol	Ratings	Unit
Diode	Forward Current (D	C)	lf	50	mA
	Reverse Voltage		Vr	5.0	V
	Power Dissipation		PD	50	mW
	Peak Forward Current <sup>*1</sup>		IFP	1	А
MOS FET	T Break Down Voltage		VL	400	V
	Continuous	Connection A	IL.	120	mA
	Load Current *2	Connection B		120	
		Connection C		240	
	Pulse Load Current <sup>*3</sup> (AC/DC Connection)		Ilp	120	mA
	Power Dissipation		Po	560	mW
Isolation Voltage *4			BV	3 750	Vr.m.s.
Total Power Dissipation			P⊤	610	mW
Operating Ambient Temperature			TA	-40 to +85	°C
Storage Te	Storage Temperature			-40 to +125	°C



\*2 Conditions: IF  $\ge$  2 mA. The following types of load connections are available.



\*3 PW = 100 ms, 1 shot

\*4 AC voltage for 1 minute at  $T_A = 25^{\circ}$ C, RH = 60% between input and output Pins 1-3 shorted together, 4-6 shorted together.

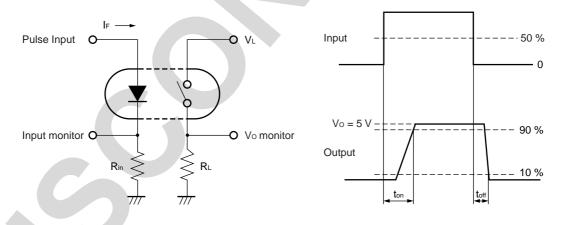
### **RECOMMENDED OPERATING CONDITIONS (TA = 25°C)**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

### ELECTRICAL CHARACTERISTICS (TA = 25°C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	V
	Reverse Current	Ir	V <sub>R</sub> = 5 V			5.0	μA
MOS FET	Off-state Leakage Current	Loff	V <sub>D</sub> = 400 V		0.001	1.0	μA
	Output Capacitance	Cout	V <sub>D</sub> = 0 V, f = 1 MHz		63		pF
Coupled	LED On-state Current	IFon	I∟ = 120 mA			2.0	mA
	On-state Resistance	Ron1	I⊧ = 10 mA, I∟ = 10 mA		27	35	Ω
		Ron2	$I_F = 10 \text{ mA}, I_L = 120 \text{ mA}, t \leq 10 \text{ ms}$		22	30	
	Turn-on Time <sup>*1, 2</sup>	ton	$I_F = 10 \text{ mA}, \text{ Vo} = 5 \text{ V}, \text{ RL} = 2 \text{ k}\Omega,$		0.55	1.0	ms
	Turn-off Time *1, 2	toff	PW ≥ 10 ms		0.07	1.0	
	Isolation Resistance	Ri-o	VI-O = 1.0 kVDC	10 <sup>9</sup>			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1 MHz		1.1		pF
	Limit Current *3	Іімт	IF = 10 mA, t = 5 ms, VL = 6 V	125	200	250	mA

\*1 Test Circuit for Switching Time



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\*2 The turn-on time and turn-off time are specified as input-pulse width ≥ 10 ms.
 Be aware that when the device operates with an input-pulse width less than 10 ms, the turn-on time and turn-off time will increase.

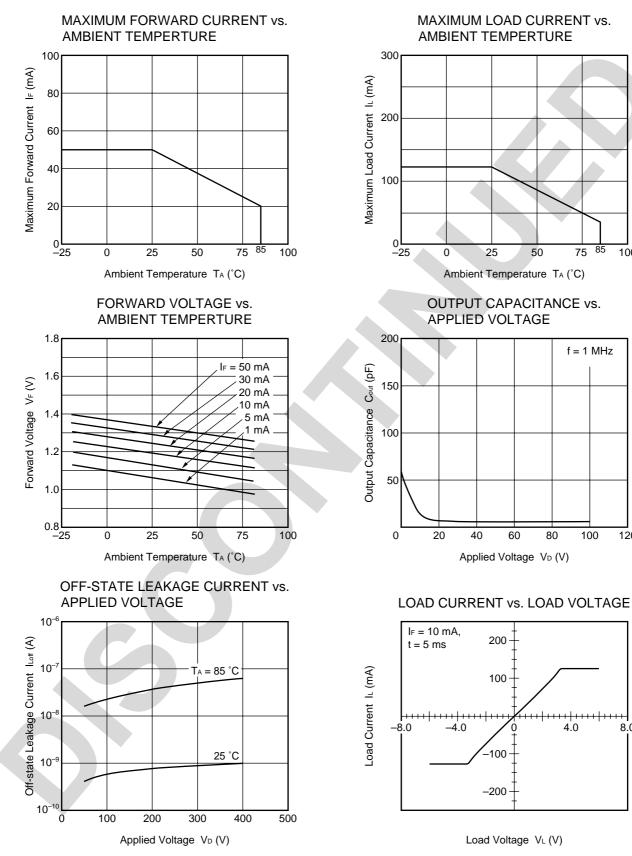
\*3 N rank : 125 to 250 mA M rank : 125 to 180 mA L rank : 170 to 250 mA

100

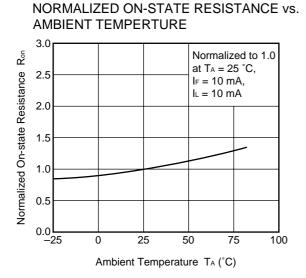
120

8.0

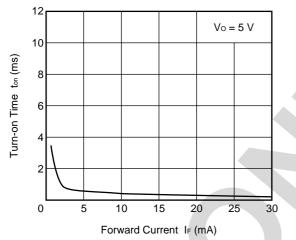
## TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)



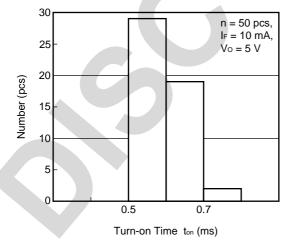
Remark The graphs indicate nominal characteristics.



### TURN-ON TIME vs. FORWARD CURRENT

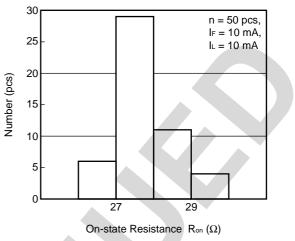


# TURN-ON TIME DISTRIBUTION

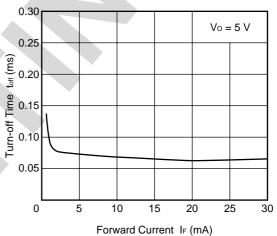


### Remark The graphs indicate nominal characteristics.

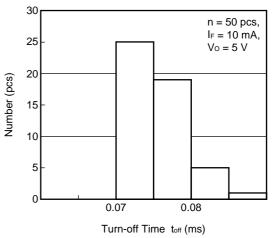
### **ON-STATE RESISTANCE DISTRIBUTION**



### TURN-OFF TIME vs. FORWARD CURRENT



### TURN-OFF TIME DISTRIBUTION



Normalized to 1.0

75

100

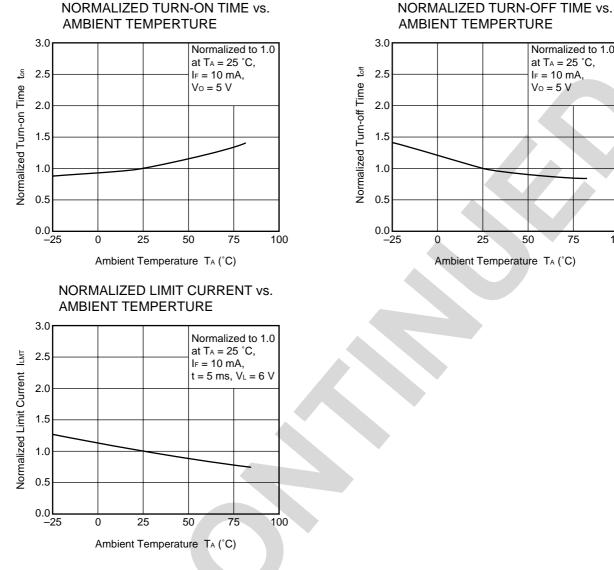
at  $T_A = 25$  °C,

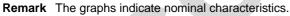
IF = 10 mA,

Vo = 5 V

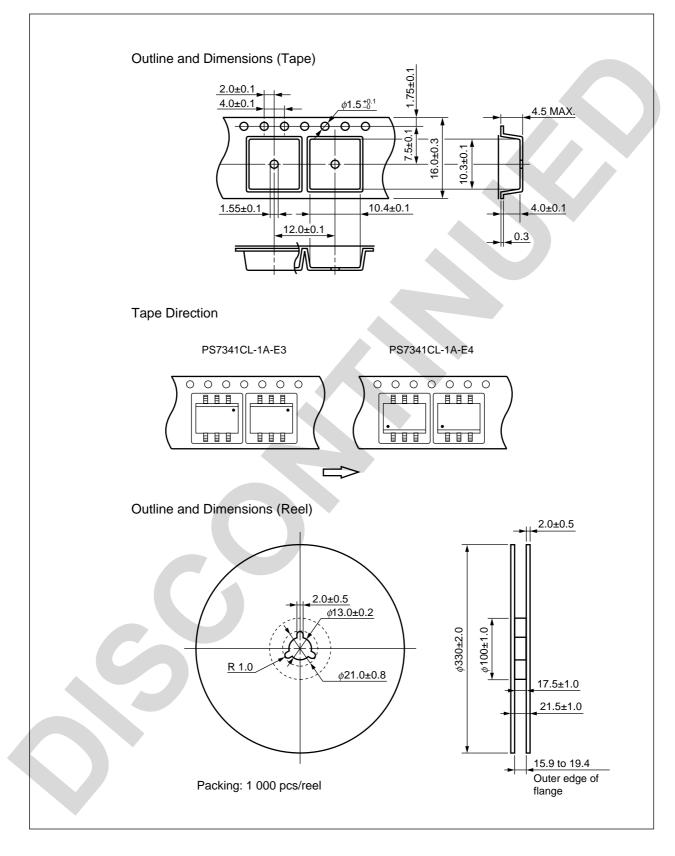
25

50





### **TAPING SPECIFICATIONS (in millimeters)**

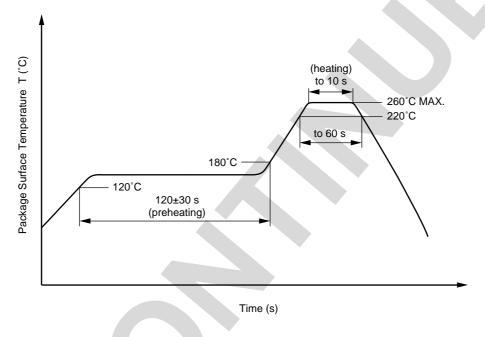


### **RECOMMENDED SOLDERING CONDITIONS**

- (1) Infrared reflow soldering
  - · Peak reflow temperature
  - Time of peak reflow temperature
  - Time of temperature higher than 220°C
  - Time to preheat temperature from 120 to 180°C
  - Number of reflows
  - Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Two Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

### Recommended Temperature Profile of Infrared Reflow



### (2) Wave soldering

- Temperature
- Time
- 10 seconds or less • Preheating conditions 120°C or below (package surface temperature)
- Number of times
- Flux

One Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

### <R> (3) Soldering by soldering iron

<ul> <li>Peak temperature (lead part temperature)</li> </ul>	350°C or below
Time (each pins)	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a
	maximum chlorine content of 0.2 Wt% is recommended.)

260°C or below (molten solder temperature)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100°C.

### (4) Cautions

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• To avoid quality degradation, assembling within 1 month after take this device out from covered pack is required. (Storage conditions 25°C, 65%RH MAX.)

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

# <R> USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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M8E 02.11-1

Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	<ol> <li>Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li> </ol>
	2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	Do not lick the product or in any way allow it to enter the mouth.

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